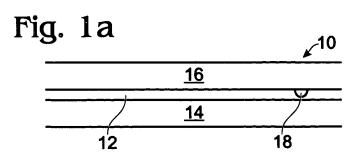
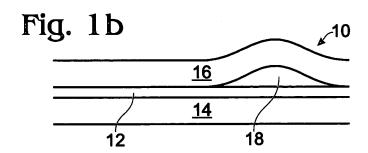
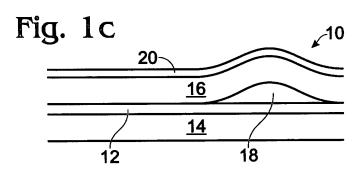
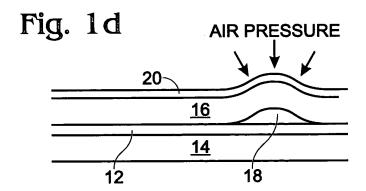


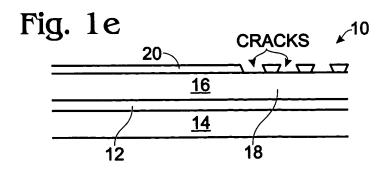
## REPLACEMENT SHEET Structure and Method for Supporting a Flexible Substrate Serial No.: 10/929,708 Hirohiko Nishiki 1/7



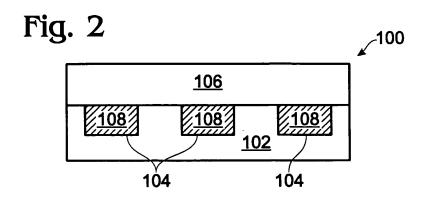


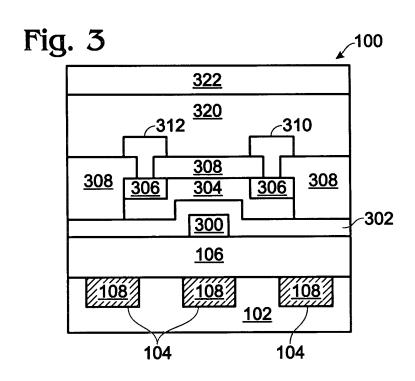


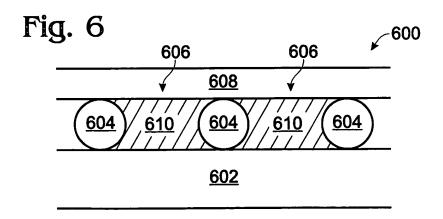


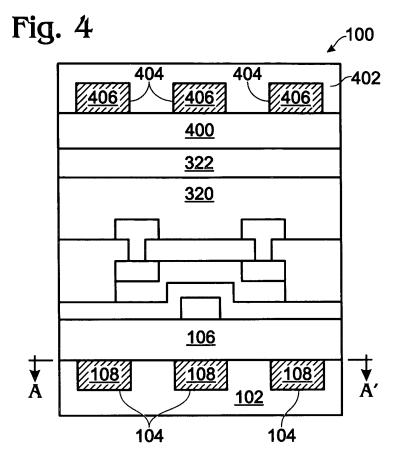


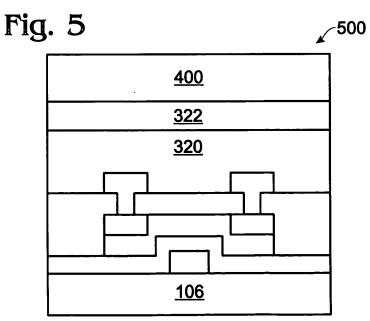
### REPLACEMENT SHEET Structure and Method for Supporting a Flexible Substrate Serial No.: 10/929,708 Hirohiko Nishiki



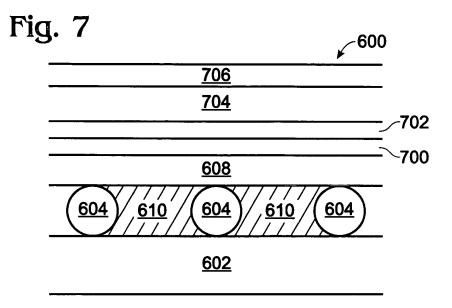


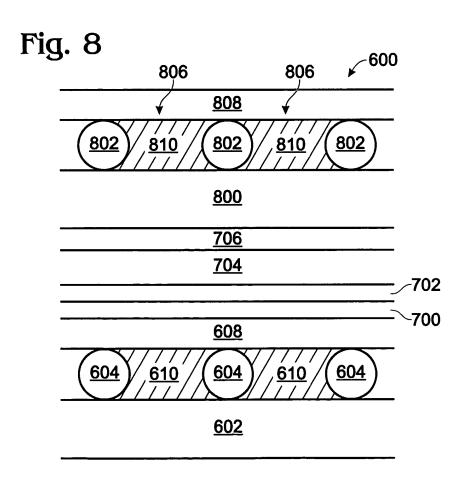


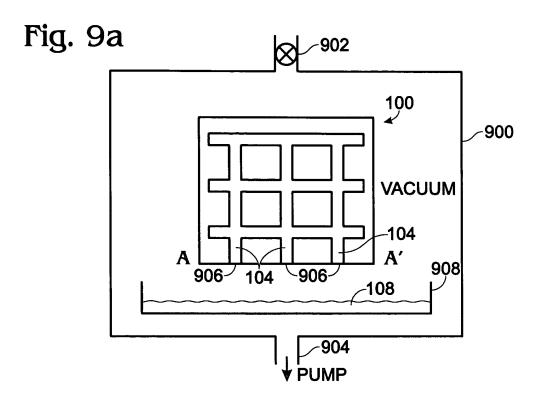


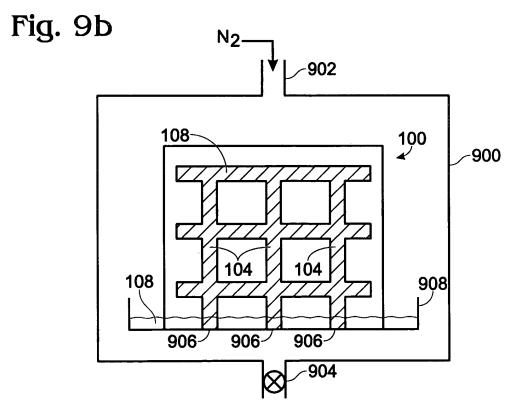


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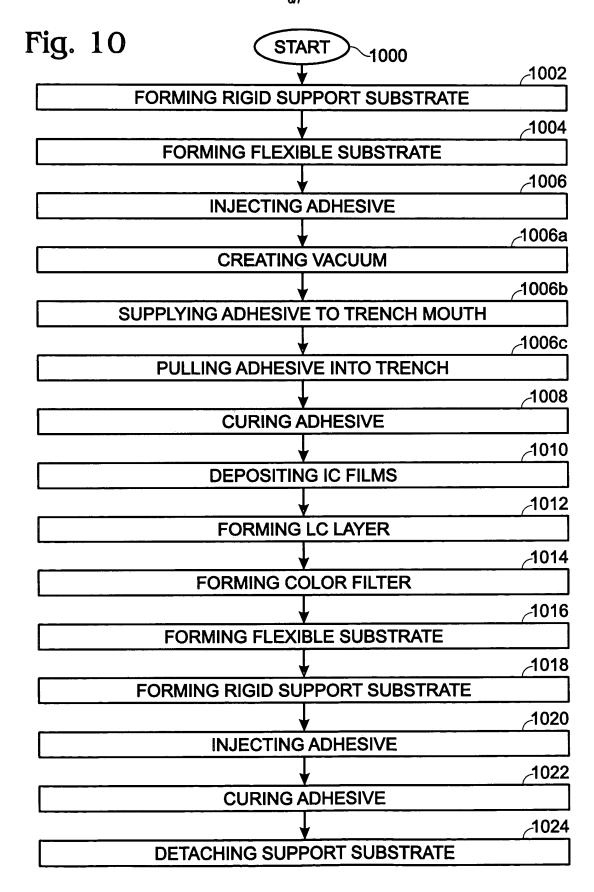








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# REPLACEMENT SHEET Structure and Method for Supporting a Flexible Substrate Serial No.: 10/929,708 Hirohiko Nishiki 7/77

Fig.	11 START 1100	
1 19.	1 1 1100	1100
	FORMING RIGID SUPPORT SUBSTRATE	<u>1102</u>
	T OTAMINE THE DESIGN OF THE TANK	
	DISTRIBUTING SPACERS	71107
	<b>+</b>	
	FORMING FLEXIBLE SUBSTRATE	7.133
	¥	_1108
	INJECTING ADHESIVE	
	<b>+</b>	_1108a
	CREATING VACUUM	
	<b>\</b>	_1108b
	SUPPLYING GLUE TO SPACER CHANNELS	
	<b>\</b>	_1108c
	RETURNING TO AMBIENT PRESSURE	
	<b>\</b>	_1108d
	PULLING ADHESIVE INTO SPACER CHANNEL	
	<u> </u>	_1110
	CURING ADHESIVE	
·	<u> </u>	
	DEPOSITING IC FILMS	
<u> </u>	<b>*</b>	
	FORMING LC LAYER	
	<u> </u>	<u>1116</u>
	FORMING COLOR FILTER	
	FORMING ELEVIPLE CUROTRATE	<u>1118</u>
	FORMING FLEXIBLE SUBSTRATE	
	DISTRIBUTING SPACERS	<u>1120</u>
	T DISTRIBUTING SPACERS	1122
<u></u>	FORMING RIGID SUPPORT SUBSTRATE	<u>1122</u>
L	T CRAINS RIGID SOFT CRY CODE TRATE	
	INJECTING ADHESIVE	71124
	THOUSAND THE STREET	
	CURING ADHESIVE	7.1.23
		 1128
	DETACHING SUPPORT SUBSTRATE(S)	, <u></u>
<b>L</b>		